

# **Effect of Various Heat Transfer Enhancement Methods on the Thermal Performance of a Latent Heat Thermal Energy Storage System**

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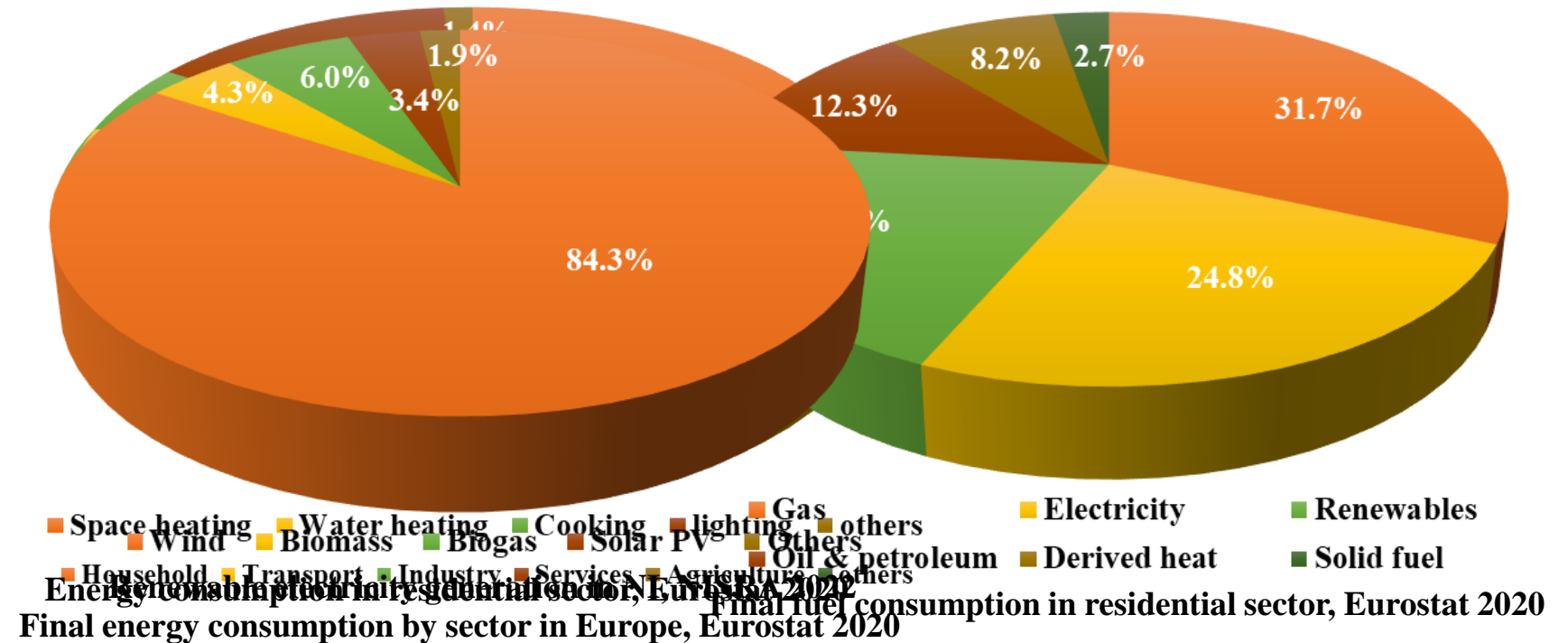
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1. Charging characteristic
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# 1. Why the thermal energy storage is important?

- In Europe, domestic sector accounts for the 28% of total energy consumption.
- Around 80% of the domestic energy consumption is for space heating and domestic hot water production
- Net zero carbon policy-2050
- Heat decarbonization through electrification
- 1300GWh wind electricity wastage since 2021
- An efficient TES technology is required to bridge the supply and demand of energy



# Classification of TES

TES

Sensible heat storage

- Stored energy is a function of specific heat and temperature difference
- Low energy storage density, high energy loss
- Water, mineral oils, brick, concrete

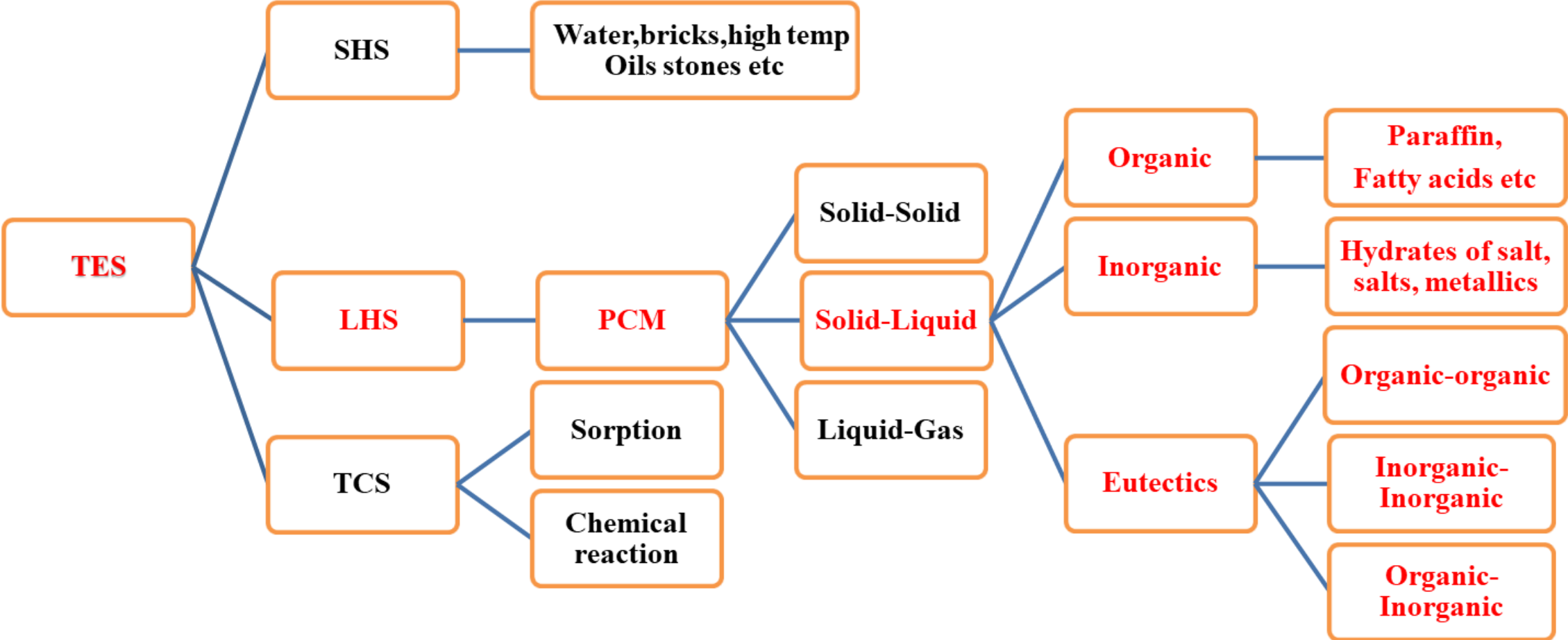
Latent heat storage

- Store energy in sensible and latent heat form
- High energy storage density than sensible storage
- Low energy loss as energy stored at a narrow temperature range
- Water, paraffin wax, salt hydrates,

Thermo chemical

- Store/ release energy during thermo chemical reaction
- High energy storage density
- low energy loss, temperature difference not involved
- Low heat transfer kinetics
- High cost
- Metal hydride, silica, zeolite, hydration of metallic oxide

# Classification of TES



## Why Phase change materials ?

- PCM materials offers most flexible operating range
- Comparatively high energy density
- High durability at reasonable cost

### Desirable properties

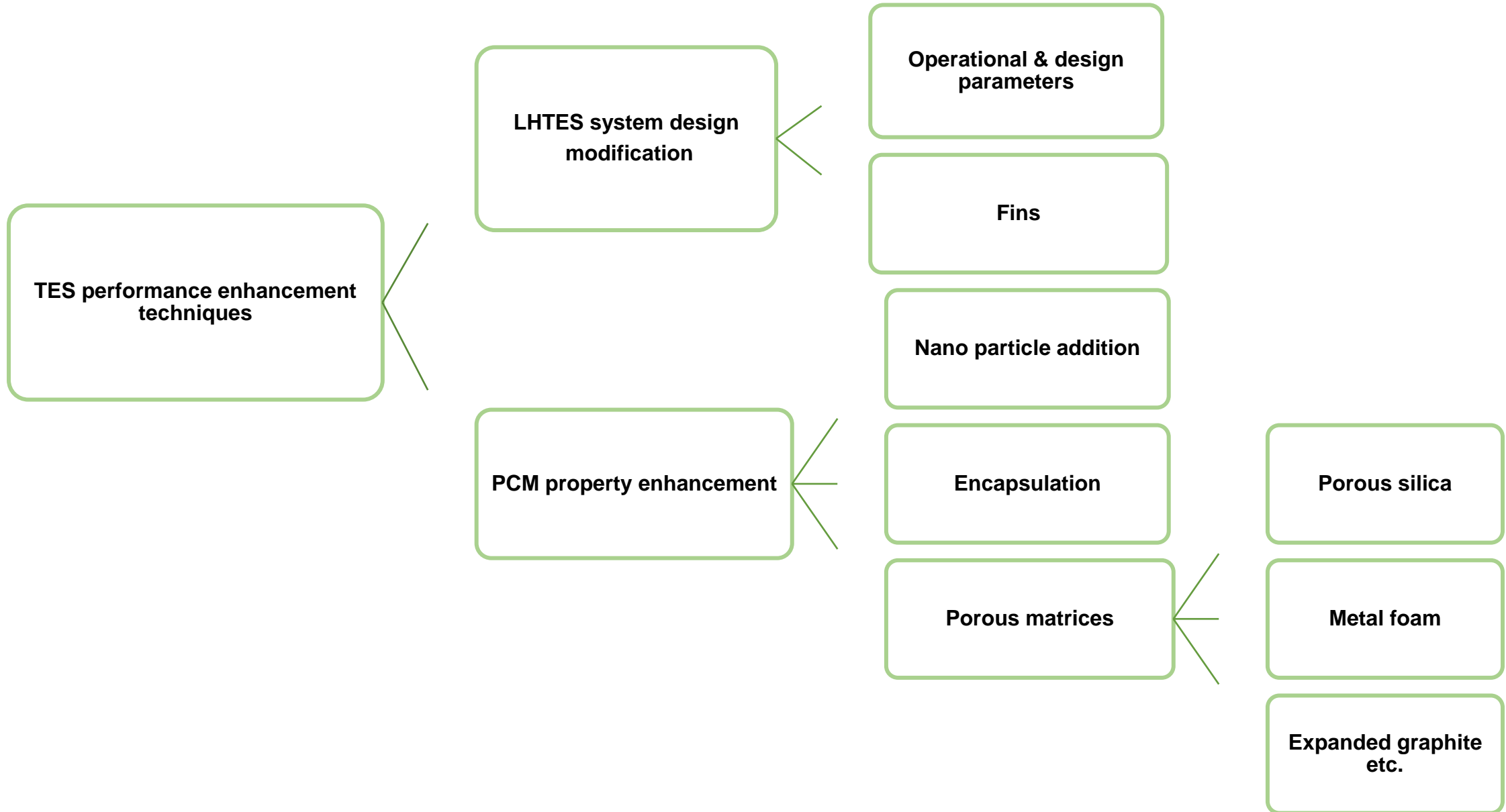
- High heat of fusion
- High thermal conductivity
- Congruent melting
- Freeze without supercooling
- High thermal reliability
- Compatibility with containment materials
- Low volumetric expansion



### Challenges

- Low thermal conductivity
- Corrosion
- Supercooling
- Volumetric expansion
- Leakage
- Thermal reliability

# How to overcome these challenges?



# Methodology



PCM



EG



PCM/EG

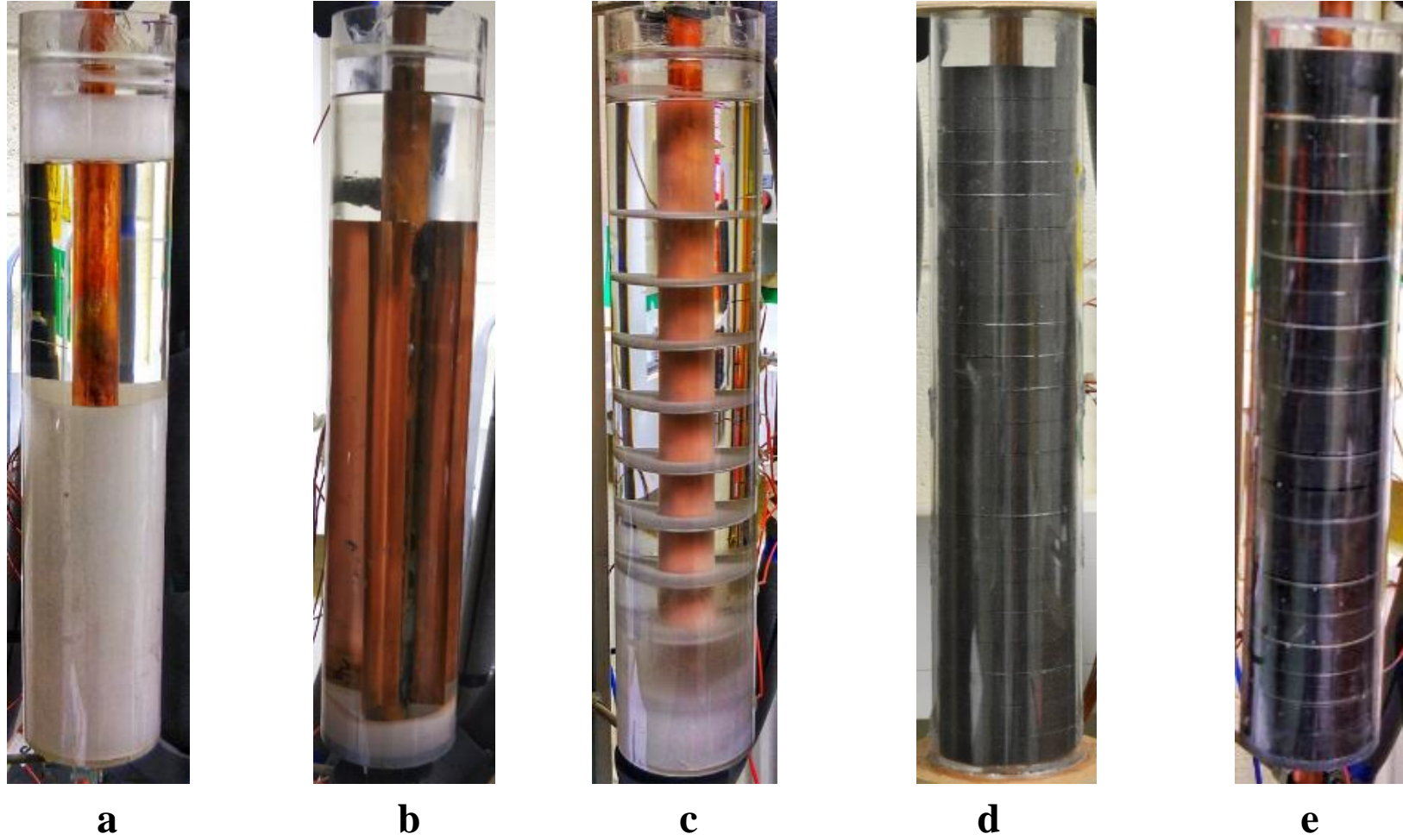


PCM/EG disc

- PCM-EG composite preparation
- PCM/25wt%EG was prepared by melt blending
- Optimization of the EG/PCM mass ratio: 15,20,25 and 30wt% of EG
- Thermo-physical property measurement: Thermal conductivity, phase change properties

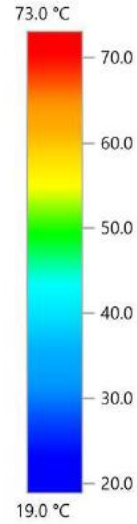
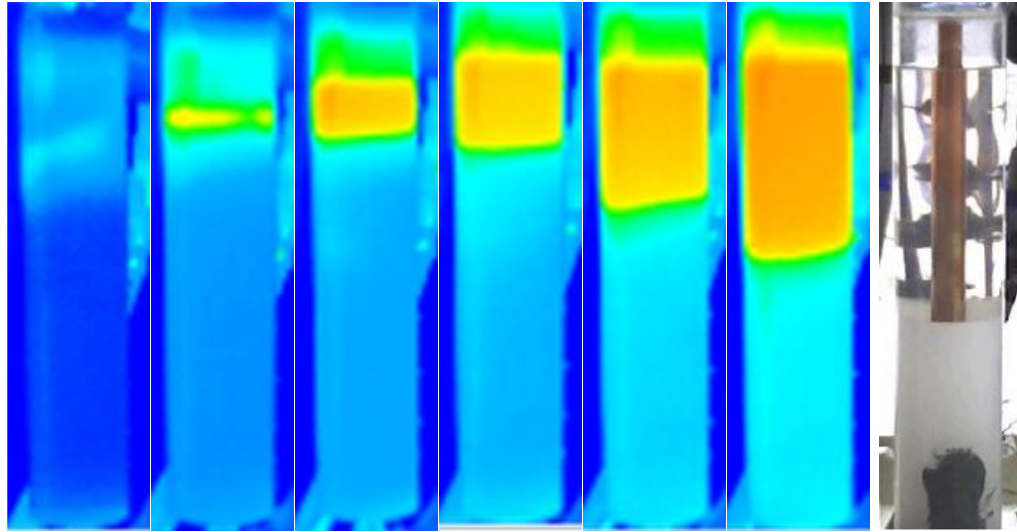


# Methodology

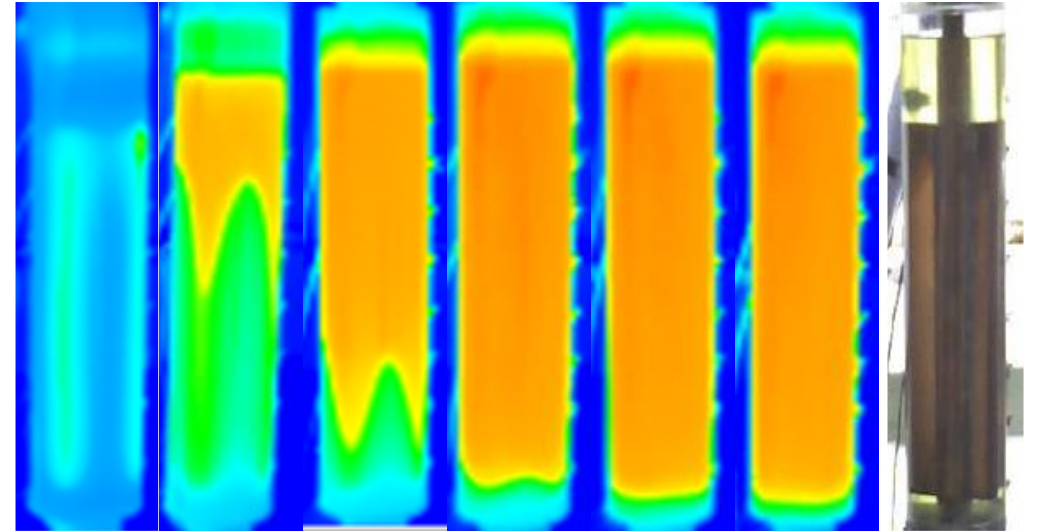


**Images of the PCM storage systems tested during this study. (a) PCM HX (b) PCM longitudinal fin HX (c) PCM circular fin HX (d) PCM/EG HX and (e) PCM/EG/fin.**

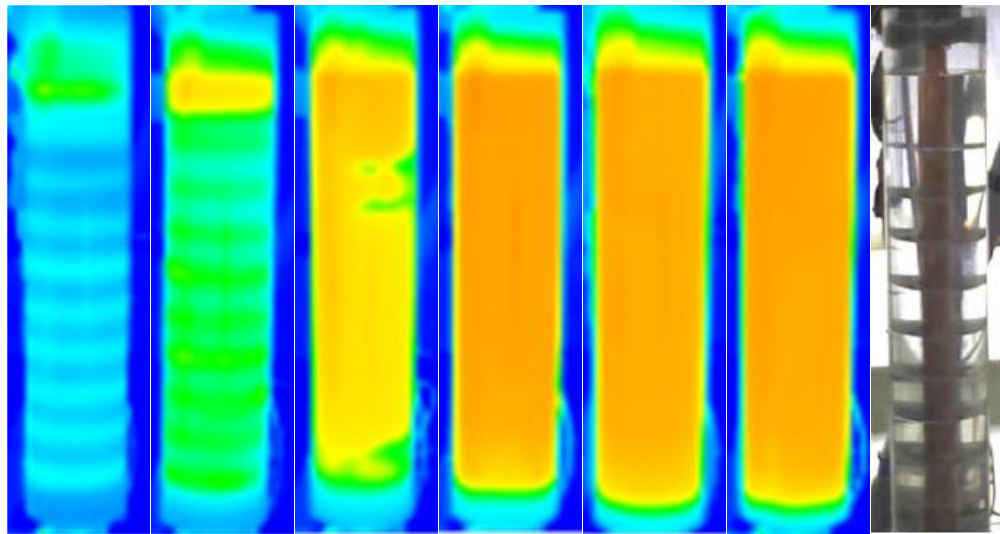
# Results



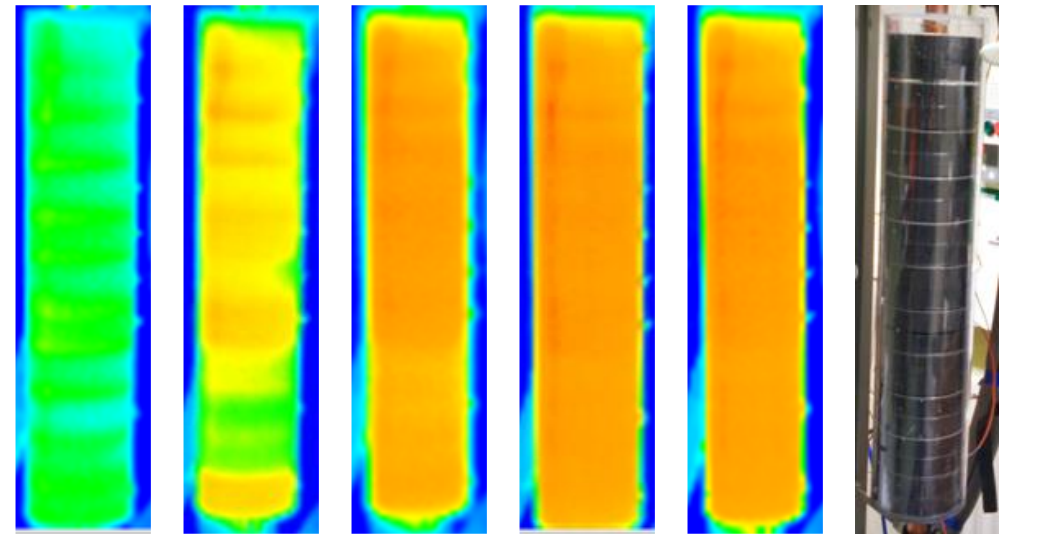
(a) PCM HX system



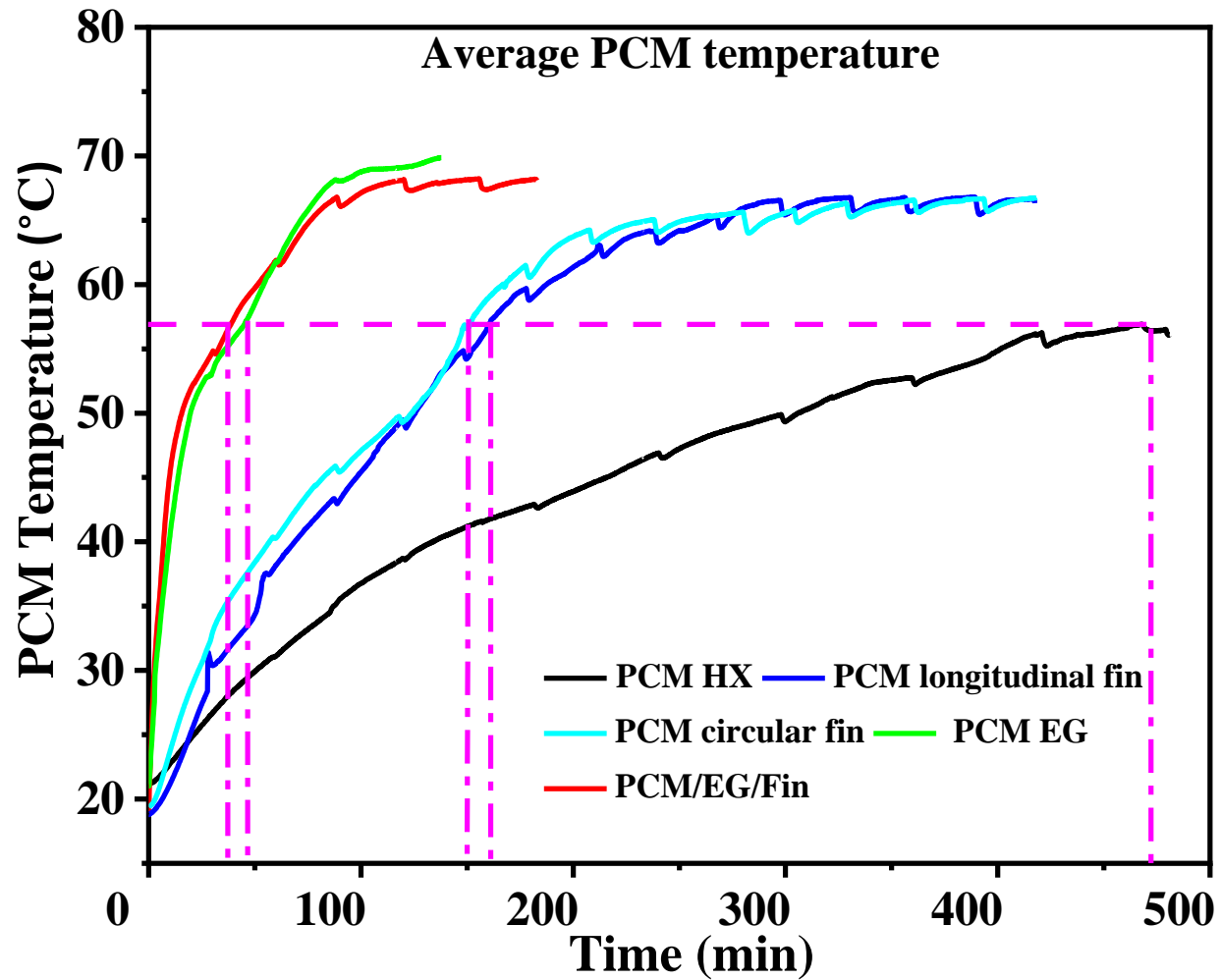
(b) PCM longitudinal fin HX system



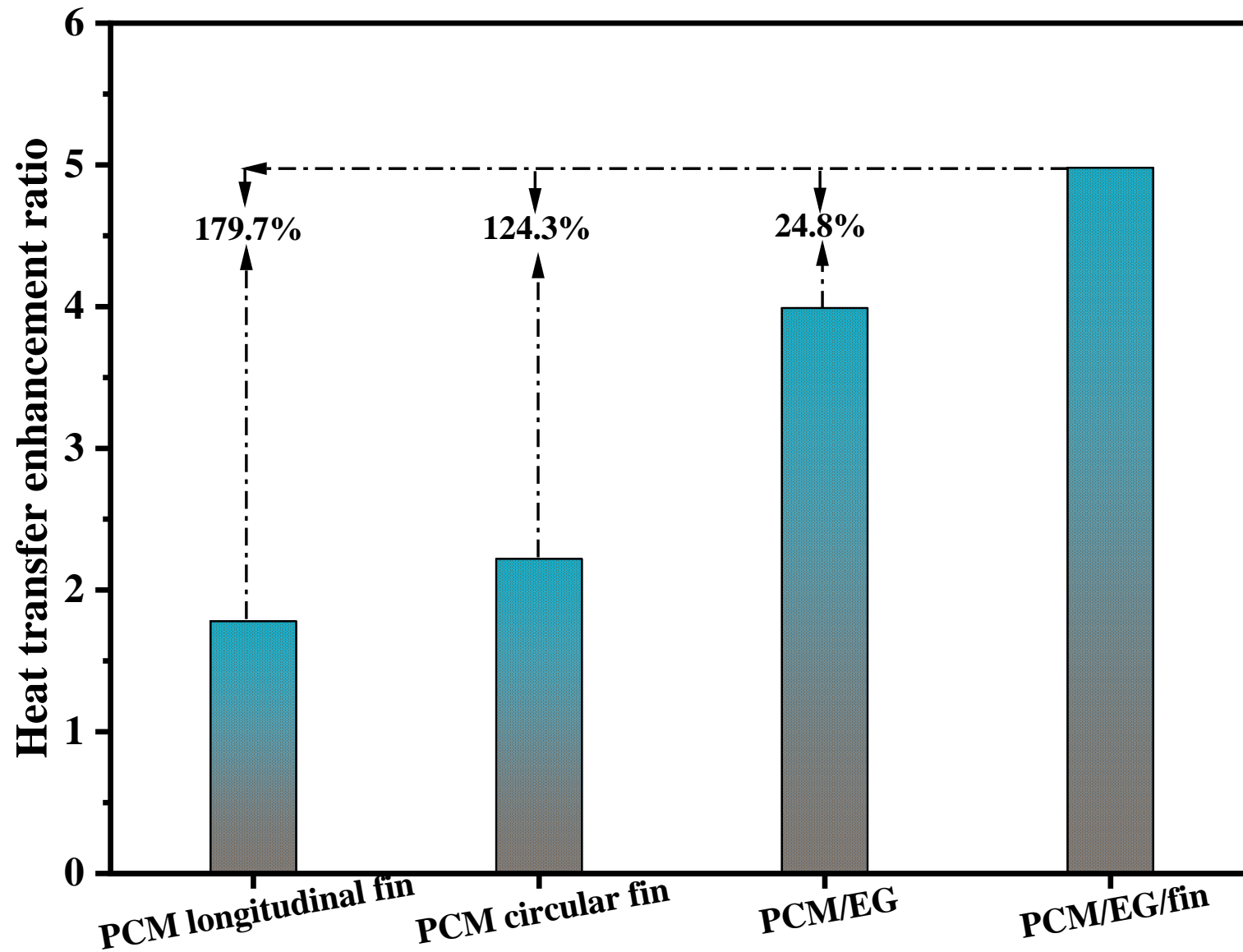
(c) PCM circular fin HX system



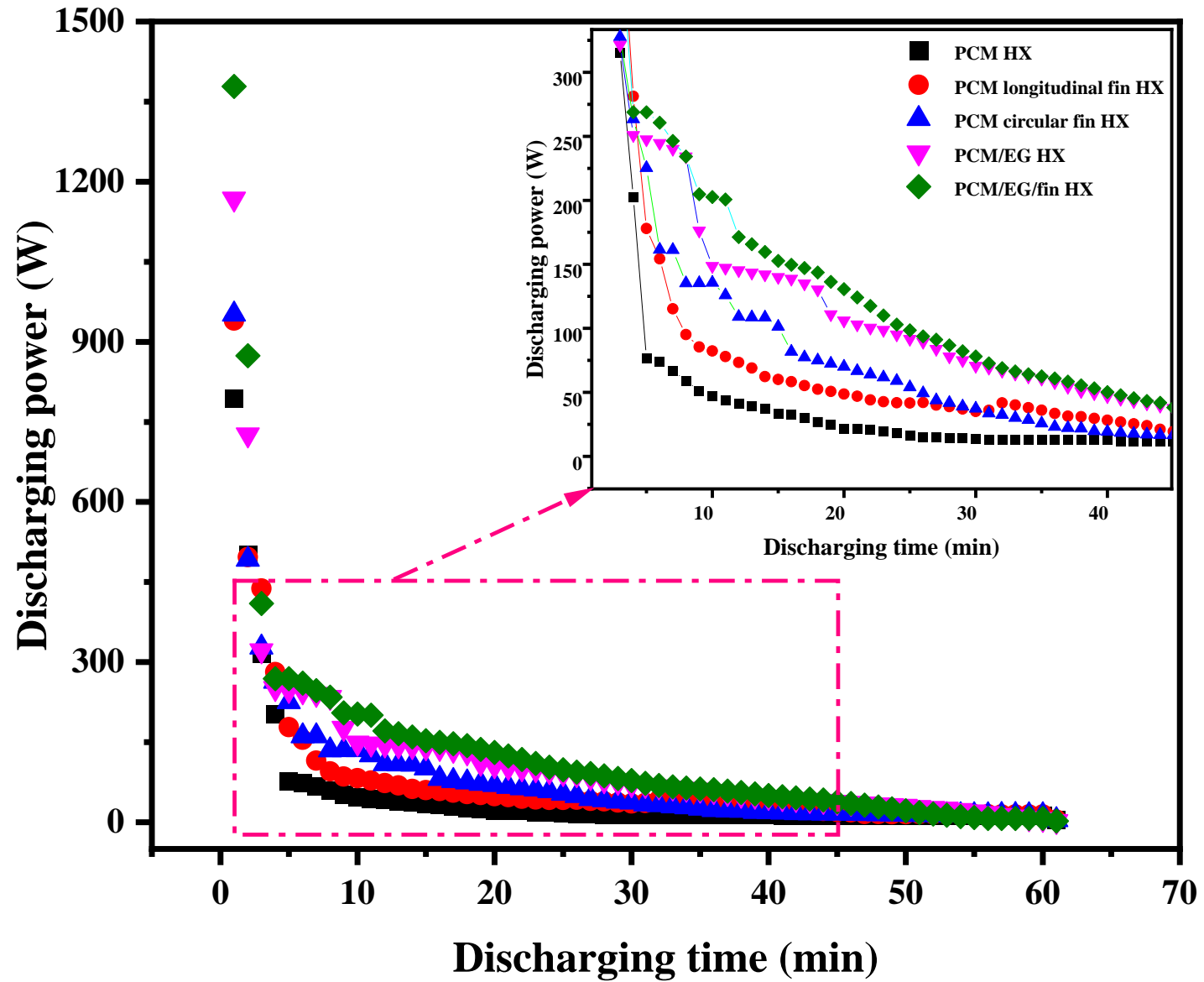
(d) PCM/EG/fin HX system



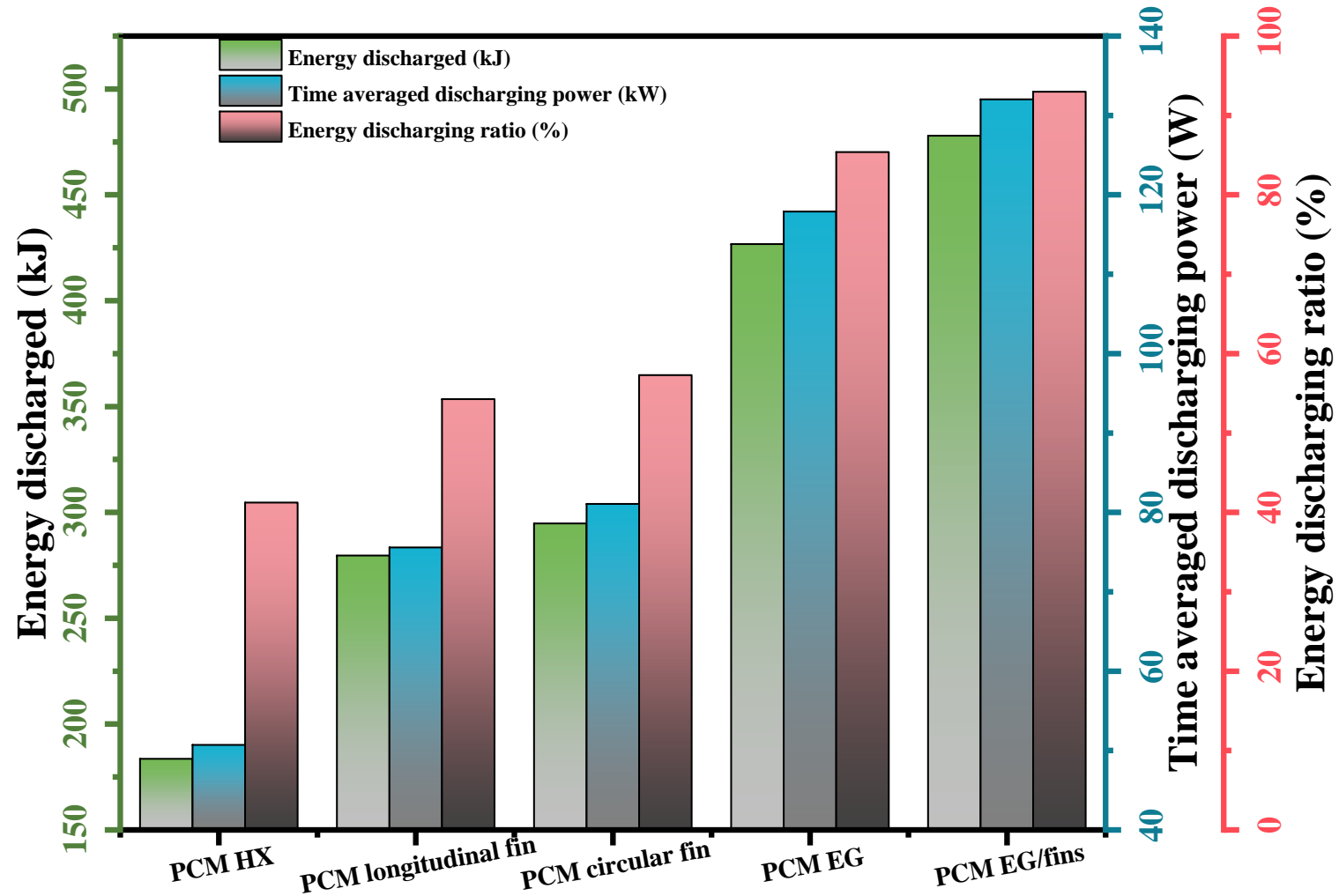
**Average PCM temperature during charging with various heat transfer enhancement methods**



**Comparison of charging heat transfer enhancement of PCM HX with the addition of various heat transfer enhancement methods.**



The intensity of thermal energy discharged from the PCM systems every 5 minutes of discharging.



**Comparison of the effect of various heat transfer enhancement methods on the discharging performance of PCM TES**

## Conclusion

- The highly conductive heat transfer network provided by the combination of EG and radial aluminium fins and the multi-pass tube arrangement resulted in uniform temperature variation during charging and discharging
- With an increase in inlet temperature of HTF from 65°C to 80°C, the overall heat transfer rate during the charging process augmented by 2.04 times and the overall charging time was reduced by 51.11% at higher charging temperature of HTF
- Conduction is the major mode of heat transfer during both the charging and discharging period.

Thank you...!

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